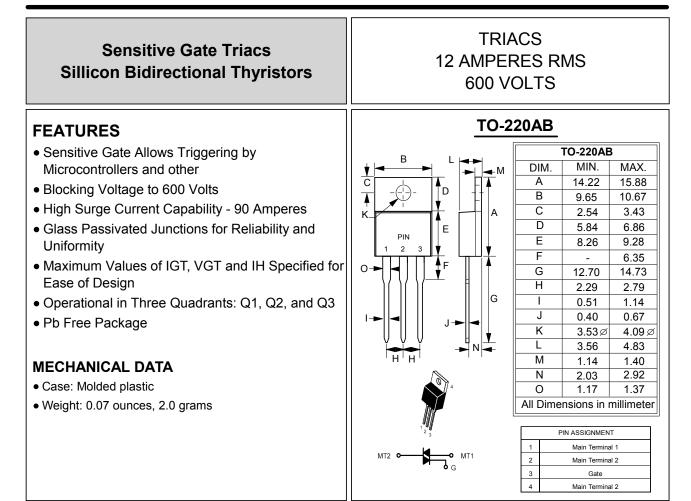
LITE ON SEMICONDUCTOR

T12M5T-B SERIES



MAXIMUM RATINGS (Tj= 25° unless otherwise noticed)

Rating	Symbol	Value	Unit
Peak Repetitive Off– State Voltage (1) (TJ= -40 to 110℃, Sine Wave, 50 to 60 Hz; Gate Open) T12M5T600B	Vdrm, Vrrm	600	Volts
On-State RMS Current (Full Cycle Sine Wave 50 to 60 Hz, Tc =70℃)	IT(RMS)	12	Amp
Peak Non-Repetitive Surge Current (One Full Cycle Sine Wave, 60 Hz, TJ= 25° C)	Ітѕм	90	Amps
Circuit Fusing Consideration (t = 8.3 ms)	l ² t	33	A ² s
Peak Gate Power (Tc = 70℃, Tp≦1.0 us)	Рдм	16	Watt
Average Gate Power (Tc = 70°C, t = 8.3 ms)	PG(AV)	0.35	Watt
Operating Junction Temperature Range	TJ	-40 to +110	°C
Storage Temperature Range	Tstg	-40 to +150	°C
lotice: (1) VDRM and VRRM for all types can be applied on a continuous basis. Blocking	REV	/. 4, Oct-2010,KT	TXC23

voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.

THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance - Junction to Case - Junction to Ambient	RthJC RthJA	2.2 62.5	°C/W
Maximum Lead Temperature for Soldering Purposes 1/8" from Case for 10 Seconds	TL	260	°C

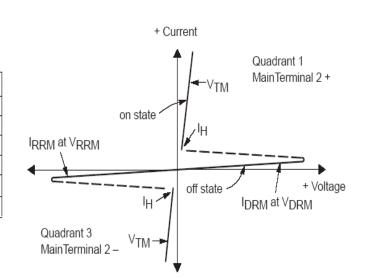
ELECTRICAL CHARACTERISTICS (TJ=25°C unless otherwise noted; Electrical apply in both directions)

Characteristics	Symbol	Min	Тур	Мах	Unit
DFF CHARACTERISTICS					
Peak Reptitive Forward or Reverse Blocking Current $T_J=25^\circ$ (VD=Rated VDRM, VRRM; Gate Open) $T_J=110^\circ$	Idrm Irrm			10 2.0	uA mA
ON CHARACTERISTICS	-				
Peak On-State Voltage (ITM=± 17A Peak @Tp \leq 2.0 ms, Duty Cycle \leq 2%)	Vтм			1.85	Volts
Gate Trigger Current (VD = 12V; RL = 100 Ohms)	IGT1 IGT2 IGT3		1.5 2.5 2.7	5.0 5.0 5.0	mA
Gate Trigger Voltage (V _D = 12 V; R _L =100 Ohms)	VGT1 VGT2 VGT3	0.45 0.45 0.45	0.68 0.62 0.67	1.5 1.5 1.5	Volts
Holding Current (V _D = 12 V, Initiating Current = \pm 200 mA, Gate Open)	Ін		2.5	10	mA
Latching Current (V _D = 12 V, IG = 5 mA)	L1 L2 L3	 	3.0 5.0 3.0	15 20 15	mA

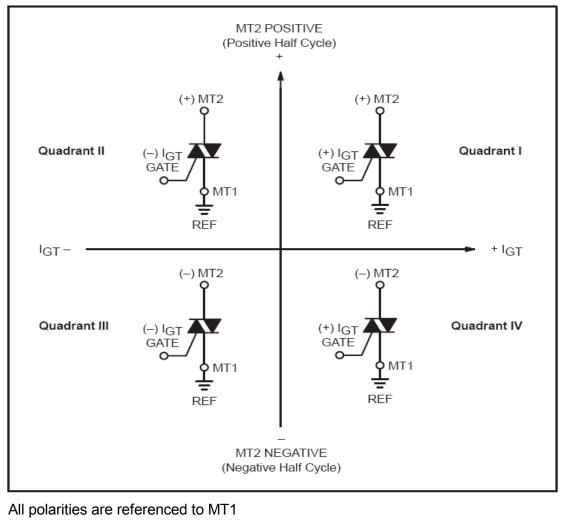
DYNAMIC CHARACTERISTICS

Rate of Change of Commutating Current (VD = 400 V, ITM = 3.5A, Commutating dv/dt = 10 V/us, Gate Open, TJ = 110° C, f = 500 Hz, Cs = 0.01 uF, Rs = 15 Ohms)	di/dt(c)	8.0	10		A/ms
Critical Rate of Rise of Off-State Voltage (VD = 67% Rated VDRM, Exponential Waveform, RGK=1K Ohms, TJ=110 $^{\circ}$ C)	dv/dt	15	40		V/us
Repetitive Critical Reat of Rise of On-State Current (IPK = 50A; PW = 40 usec; diG/dt = 1A/usec;lgt = 100mA; f= 60Hz)	di/dt			10	A/us

Symbol	Parameter
VDRM	Peak Repetitive Forward Off State Voltage
IDRM	Peak Forward Blocking Current
VRRM	Peak Repetitive Reverse Off State Voltage
IRRM	Peak Reverse Blocking Current
VTM	Maximum On State Voltage
ΙΗ	Holding Current



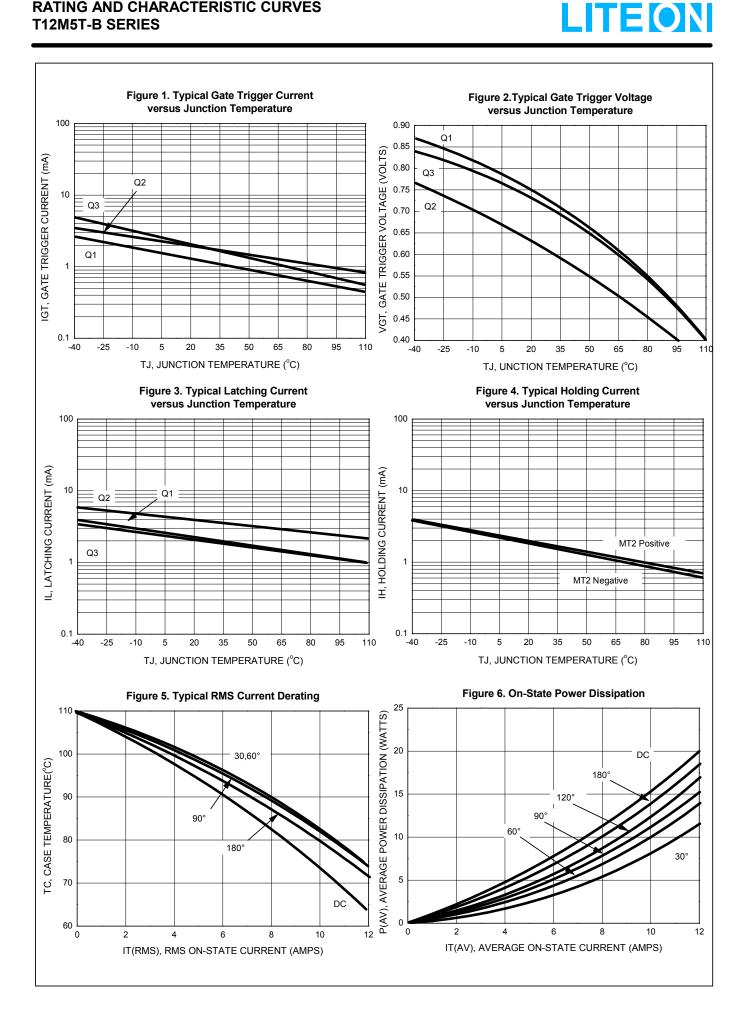
Quadrant Definitions



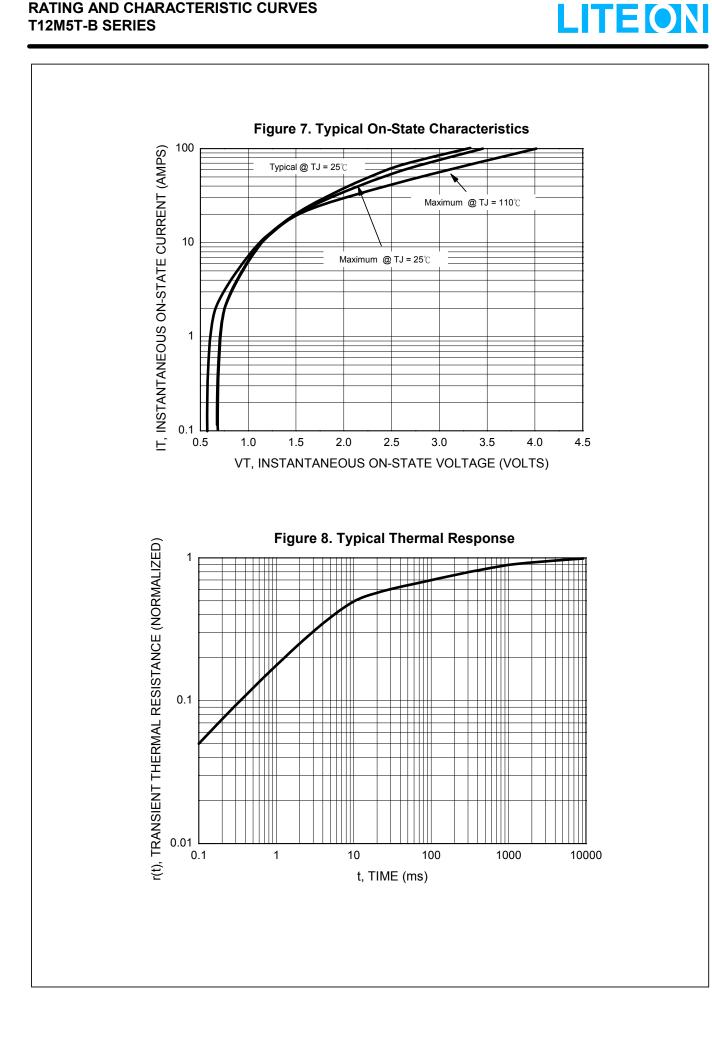
Whith in -phase signal (using standard AC lines) quadrants I and III are used

LITE ON

RATING AND CHARACTERISTIC CURVES T12M5T-B SERIES



RATING AND CHARACTERISTIC CURVES T12M5T-B SERIES





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